High Voltage, High and Low Side Driver

The NCP5111 is a high voltage power gate driver providing two outputs for direct drive of 2 N-channel power MOSFETs or IGBTs arranged in a half-bridge configuration.

It uses the bootstrap technique to ensure a proper drive of the high-side power switch.

Features

- High Voltage Range: up to 600 V
- dV/dt Immunity ±50 V/nsec
- Gate Drive Supply Range from 10 V to 20 V
- High and Low Drive Outputs
- Output Source / Sink Current Capability 250 mA / 500 mA
- 3.3 V and 5 V Input Logic Compatible
- Up to V_{CC} Swing on Input Pins
- Extended Allowable Negative Bridge Pin Voltage Swing to -10 V for Signal Propagation
- Matched Propagation Delays between Both Channels
- One Input with Internal Fixed Dead Time (650 ns)
- Under V_{CC} LockOut (UVLO) for Both Channels
- Pin–to–Pin Compatible with Industry Standards
- These are Pb–Free Devices

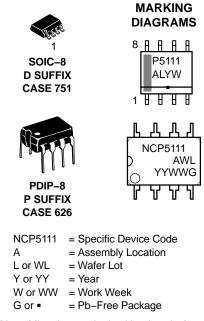
Typical Applications

• Half–bridge Power Converters



ON Semiconductor®

www.onsemi.com



(Note: Microdot may be in either location)

PINOUT INFORMATION

VCC 📼	1	8 P VBOOT
IN EE GND EE	2	7 = DRV_HI
	3	
DRV_LO =	4	5 - NC

ORDERING INFORMATION

Device	Package	Shipping [†]
NCP5111PG	PDIP-8 (Pb-Free)	50 Units / Rail
NCP5111DR2G	SOIC-8 (Pb-Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

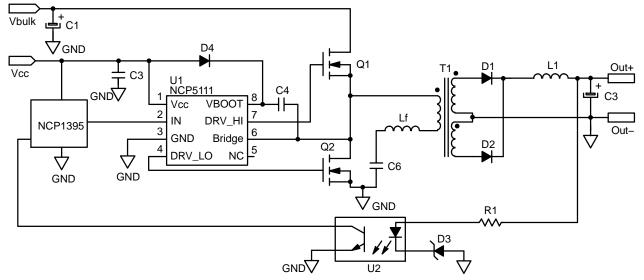


Figure 1. Typical Application Resonant Converter (LLC type)

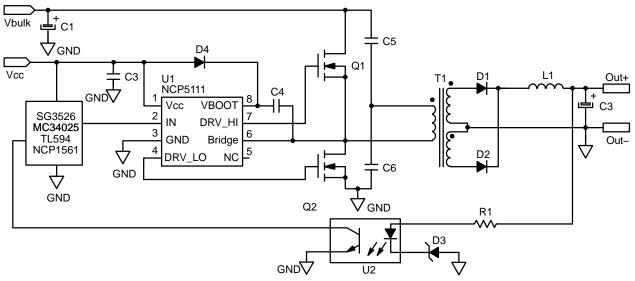


Figure 2. Typical Application Half Bridge Converter

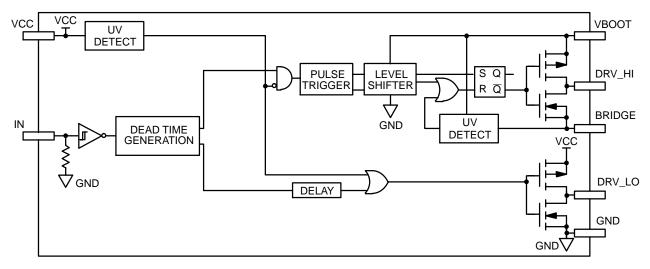


Figure 3. Detailed Block Diagram

PIN DESCRIPTIONS

Pin No.	Pin Name	Pin Function
1	VCC	Low side and main power supply
2	IN	Logic Input
3	GND	Ground
4	DRV_LO	Low side gate drive output
5	NC	Not Connected
6	BRIDGE	Bootstrap return or high side floating supply return
7	DRV_HI	High side gate drive output
8	VBOOT	Bootstrap power supply

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
V _{CC}	Main power supply voltage	-0.3 to 20	V
V _{CC_transient}	Main transient power supply voltage: IV _{CC_max} = 5 mA during 10 ms	23	V
V _{BRIDGE}	VHV: High Voltage BRIDGE pin	-1 to 600	V
VBRIDGE	Allowable Negative Bridge Pin Voltage for IN_LO Signal Propagation to DRV_LO	-10	V
V _{BOOT} -V _{BRIDGE}	VHV: Floating supply voltage	-0.3 to 20	V
V _{DRV_HI}	VHV: High side output voltage	V _{BRIDGE} – 0.3 to V _{BOOT} + 0.3	V
V _{DRV_LO}	Low side output voltage	–0.3 to V _{CC} + 0.3	V
dV _{BRIDGE} /dt	Allowable output slew rate	50	V/ns
V _{IN}	Inputs IN	–1.0 to V _{CC} + 0.3	V
	ESD Capability: – HBM model (all pins except pins 6–7–8) – Machine model (all pins except pins 6–7–8)	2	kV
		200	V
	Latchup capability per JEDEC JESD78		
$R_{ hetaJA}$	Power dissipation and Thermal characteristics PDIP–8: Thermal Resistance, Junction–to–Air SO–8: Thermal Resistance, Junction–to–Air	100 178	°C/W
T _{STG}	Storage Temperature Range	-55 to +150	°C
T _{J_max}	Maximum Operating Junction Temperature	+150	°C

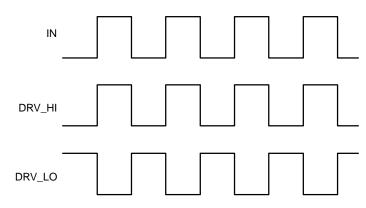
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTIC (V _{CC} = V _{boot} = 15 V, V _{GND} = V _{bridge} , -	$-40^{\circ}C < T_{J} < 125^{\circ}C$, Outputs loaded with 1 nF)
---	---

		T _J –40°C to 125°C			
Rating	Symbol	Min	Тур	Max	Units
OUTPUT SECTION					
Output high short circuit pulsed current V _{DRV} = 0 V, PW \leq 10 µs (Note 1)	I _{DRVsource}	_	250	-	mA
Output low short circuit pulsed current V_{DRV} = Vcc, PW \leq 10 µs (Note 1)	I _{DRVsink}	_	500	-	mA
Output resistor (Typical value @ 25°C) Source	R _{OH}	_	30	60	Ω
Output resistor (Typical value @ 25°C) Sink	R _{OL}	_	10	20	Ω
High level output voltage, V _{BIAS} –V _{DRV_XX} @ I _{DRV_XX} = 20 mA	V _{DRV_H}	_	0.7	1.6	V
Low level output voltage V _{DRV_XX} @ I _{DRV_XX} = 20 mA	V _{DRV_L}	_	0.2	0.6	V
DYNAMIC OUTPUT SECTION	· · ·				
Turn–on propagation delay (Vbridge = 0 V) (Note 2)	t _{ON}	-	750	1170	ns
Turn–off propagation delay (Vbridge = 0 V or 50 V) (Notes 2 and 3)	t _{OFF}	-	100	170	ns
Output voltage rise time (from 10% to 90% @ Vcc = 15 V) with 1 nF load	tr	-	85	160	ns
Output voltage fall time (from 90% to 10% $@V_{CC} = 15 \text{ V}$) with 1 nF load	tf	-	35	75	ns
Propagation delay matching between the High side and the Low side @ 25°C (Note 4)	Δt	-	30	60	ns
Internal fixed dead time (Note 5)	DT	400	650	1000	ns
INPUT SECTION	· · ·				
Low level input voltage threshold	V _{IN}	_	-	0.8	V
Input pull–down resistor (V _{IN} < 0.5 V)	R _{IN}	_	200	-	kΩ
High level input voltage threshold	V _{IN}	2.3	-	-	V
Logic "1" input bias current @ $V_{IN} = 5 V$ @ $25^{\circ}C$	I _{IN+}	_	5	25	μΑ
Logic "0" input bias current @ $V_{IN} = 0 V$ @ 25°C	I _{IN-}	_	-	2.0	μΑ
SUPPLY SECTION					
Vcc UV Start-up voltage threshold	Vcc_stup	8.0	8.9	9.9	V
Vcc UV Shut-down voltage threshold	Vcc_shtdwn	7.3	8.2	9.1	V
Hysteresis on Vcc	Vcc_hyst	0.3	0.7	-	V
Vboot Start–up voltage threshold reference to bridge pin (Vboot_stup = Vboot – Vbridge)	Vboot_stup	8.0	8.9	9.9	V
Vboot UV Shut-down voltage threshold	Vboot_shtdwn	7.3	8.2	9.1	V
Hysteresis on Vboot	Vboot_shtdwn	0.3	0.7	-	V
Leakage current on high voltage pins to GND	I _{HV_LEAK}	_	5	40	μΑ
$(V_{BOOT} = V_{BRIDGE} = DRV_HI = 600 V)$	_				
Consumption in active mode (Vcc = Vboot, $fsw = 100 \text{ kHz}$ and 1 nF load on both driver outputs)	ICC1	_	4	5	mA
Consumption in inhibition mode (Vcc = Vboot)	ICC2	-	250	400	μΑ
Vcc current consumption in inhibition mode	ICC3	-	200	-	μΑ
Vboot current consumption in inhibition mode	ICC4	_	50	_	μA

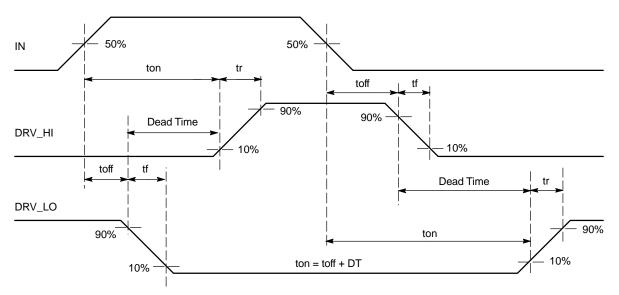
1. Parameter guaranteed by design.

Parameter guaranteed by design.
T_{ON} = T_{OFF} + DT.
Turn-off propagation delay @ Vbridge = 600 V is guaranteed by design.
See characterization curve for ∆t parameters variation on the full range temperature.
Timing diagram definition see: Figure 5 and Figure 6.
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

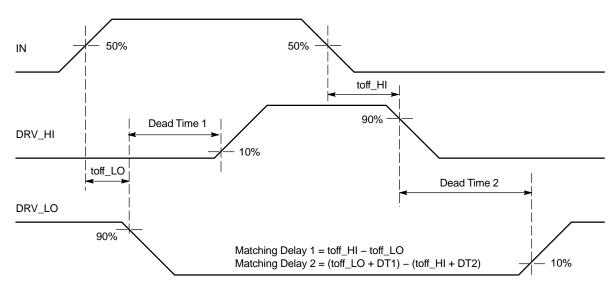


Note: DRV_HI output is in phase with the input.

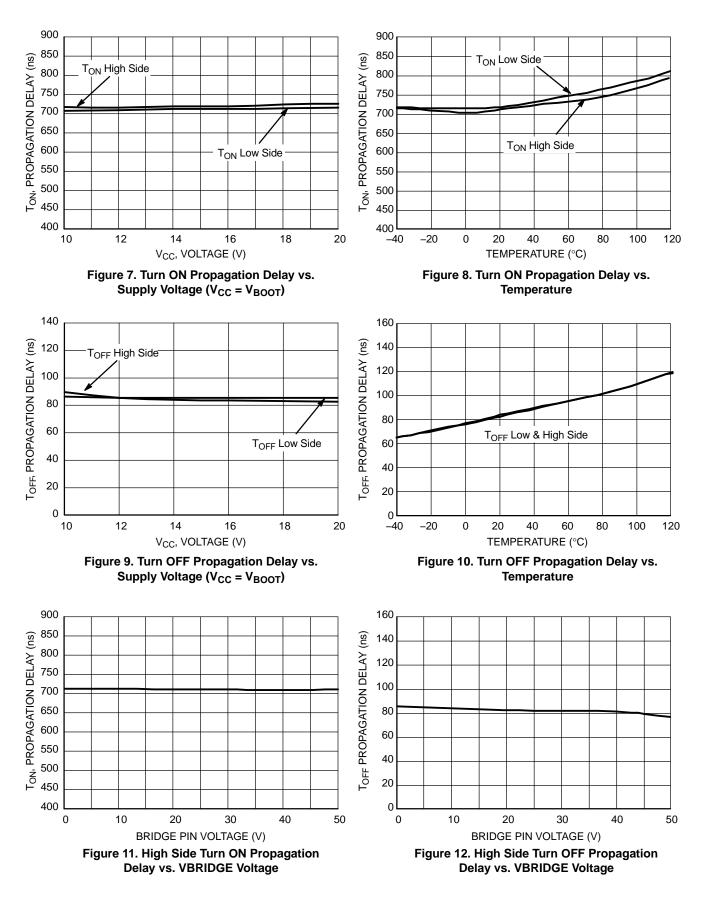
Figure 4. Input/Output Timing Diagram

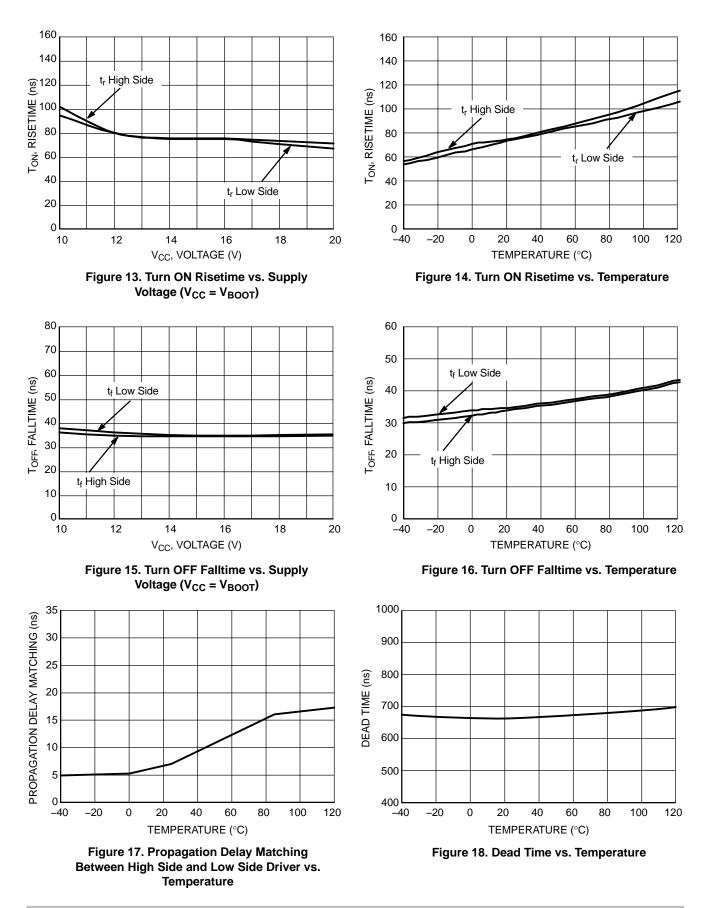


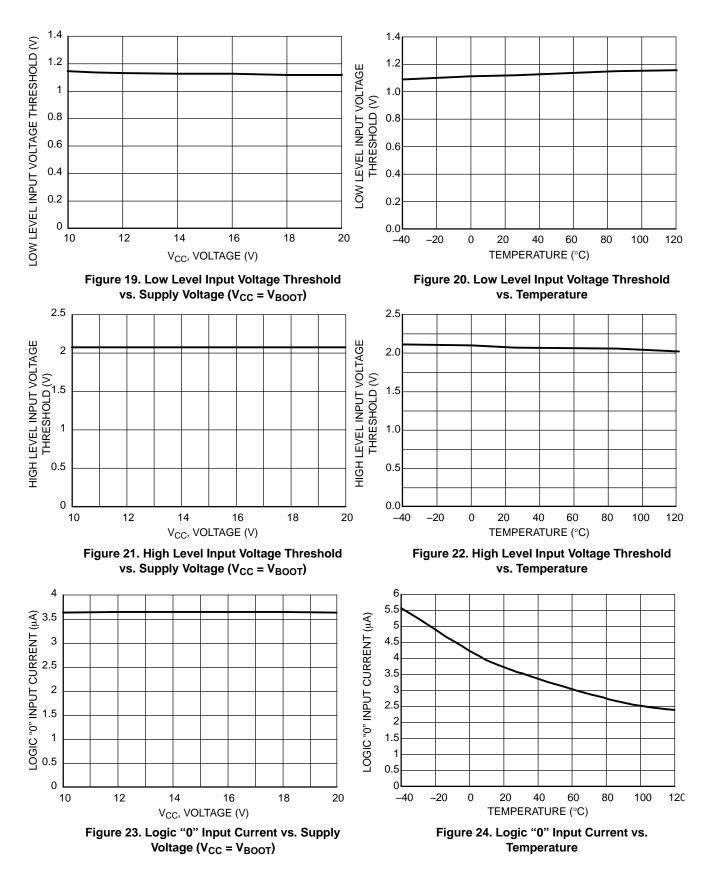


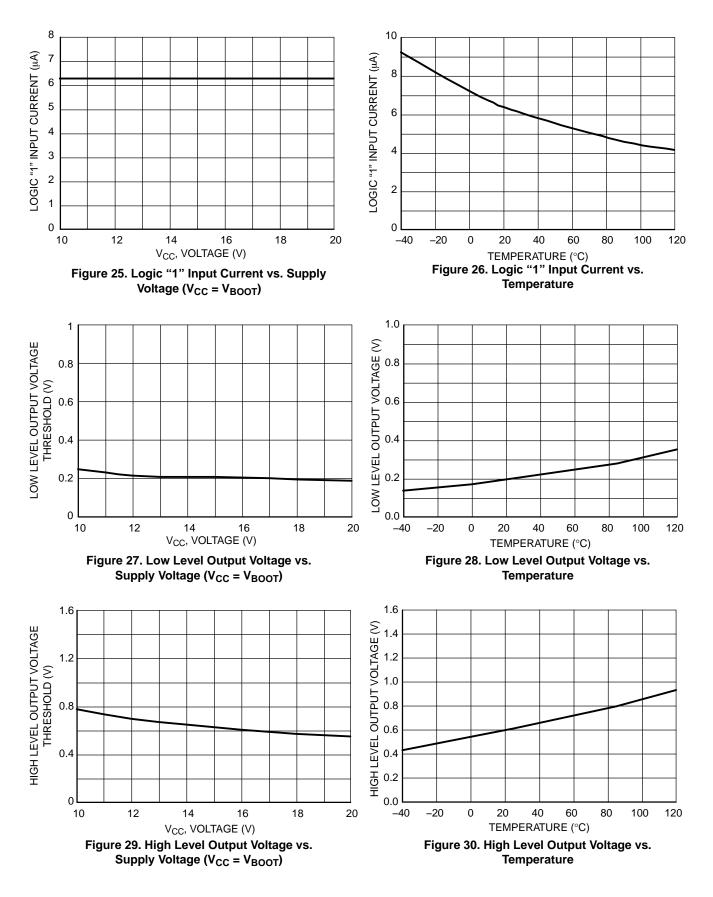


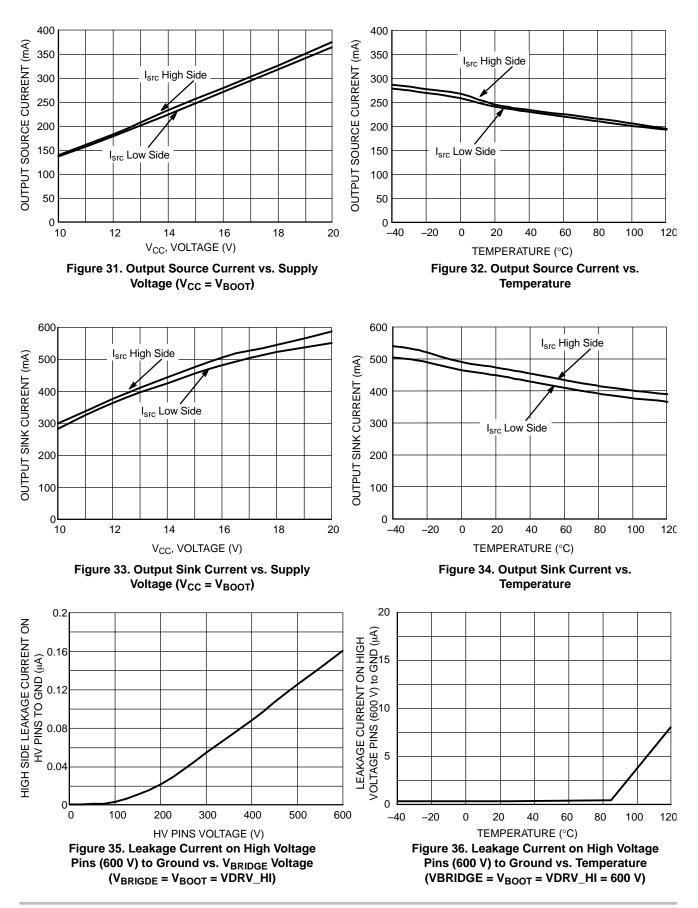


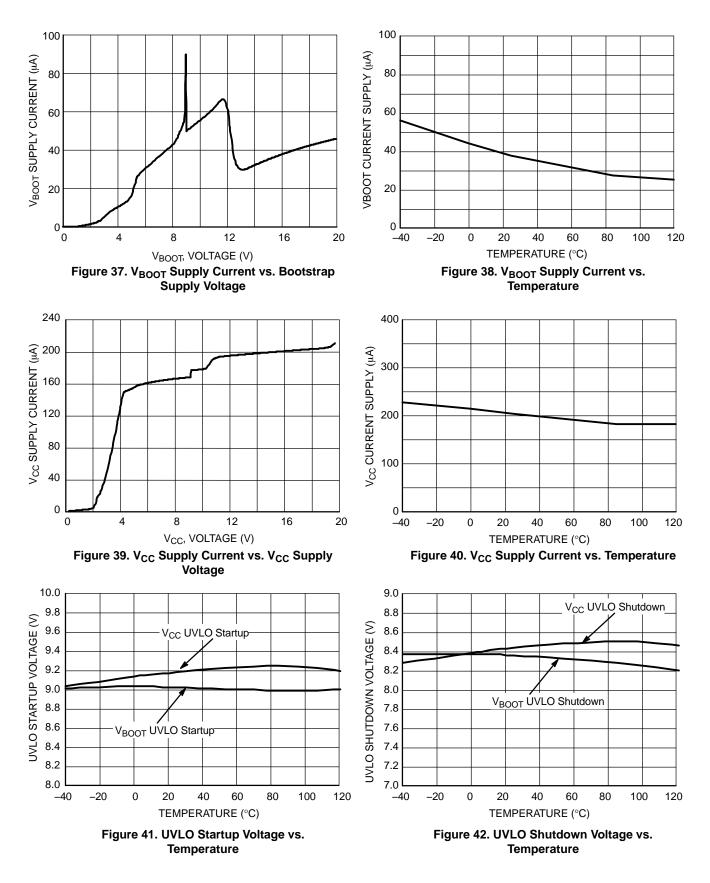




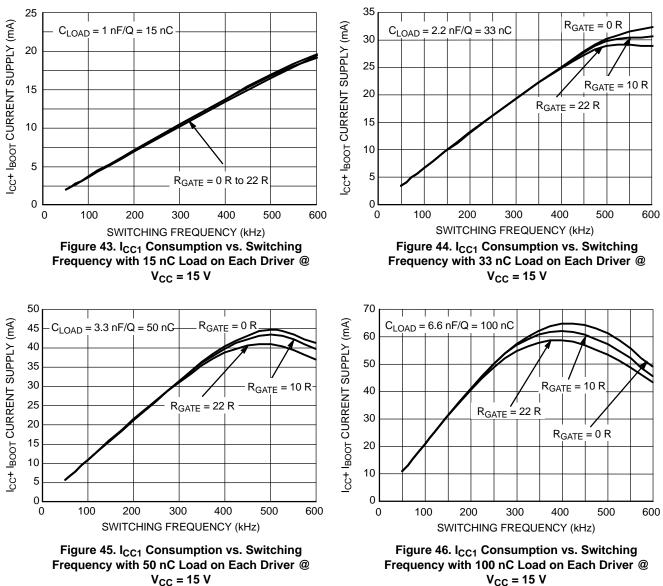






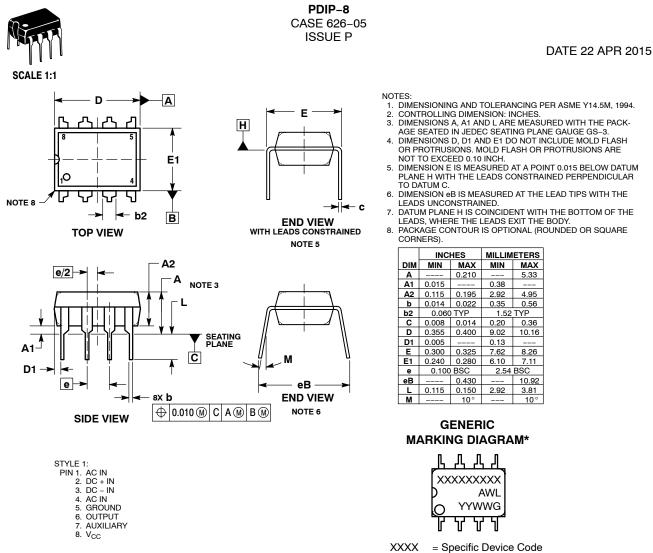


CHARACTERIZATION CURVES



 $V_{CC} = 15 V$

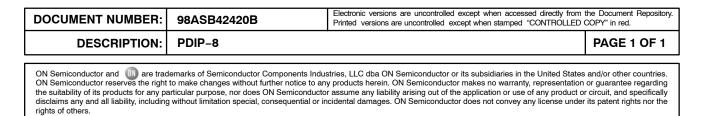




A = Assembly Location

- WL = Wafer Lot
- YY = Year
- WW = Work Week
- G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.



onsemí



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

DOCUMENT NUMBER:	98ASB42564B	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION: SOIC-8 NB PAGE 1 OF					
the right to make changes without furth purpose, nor does onsemi assume ar	onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.				

SOIC-8 NB CASE 751-07 ISSUE AK

STYLE 1: PIN 1. EMITTER COLLECTOR 2. 3. COLLECTOR 4. EMITTER 5. EMITTER BASE 6. 7 BASE EMITTER 8. STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN DRAIN 4. GATE 5. 6. GATE SOURCE 7. 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON COLLECTOR, DIE #1 COLLECTOR, DIE #2 2. З. EMITTER, COMMON 4. 5. EMITTER, COMMON 6 BASE. DIE #2 BASE, DIE #1 7. 8. EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3 GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. DRAIN 8. STYLE 17: PIN 1. VCC 2. V2OUT V10UT З. TXE 4. 5. RXE 6. VFF 7. GND 8. ACC STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3 CATHODE 3 CATHODE 4 4. 5. CATHODE 5 6. COMMON ANODE COMMON ANODE 7. 8. CATHODE 6 STYLE 25: PIN 1. VIN 2 N/C REXT З. 4. GND 5. IOUT IOUT 6. IOUT 7. 8. IOUT STYLE 29: BASE, DIE #1 PIN 1. 2 EMITTER, #1 BASE, #2 З. EMITTER, #2 4. 5 COLLECTOR, #2 COLLECTOR, #2 6.

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 COLLECTOR, #2 3. COLLECTOR, #2 4 BASE, #2 5. EMITTER, #2 6. 7 BASE #1 EMITTER, #1 8. STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN SOURCE 4. SOURCE 5. 6. GATE GATE 7. 8. SOURCE STYLE 10: GROUND PIN 1. BIAS 1 OUTPUT 2. З. GROUND 4. 5. GROUND 6 BIAS 2 INPUT 7. 8. GROUND STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3 P-SOURCE P-GATE 4. P-DRAIN 5 6. P-DRAIN N-DRAIN 7. N-DRAIN 8. STYLE 18: PIN 1. ANODE ANODE 2. SOURCE 3. GATE 4. 5. DRAIN 6 DRAIN CATHODE 7. 8. CATHODE STYLE 22 PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3 COMMON CATHODE/VCC 4. I/O LINE 3 COMMON ANODE/GND 5. 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GND STYLE 26: PIN 1. GND 2 dv/dt З. ENABLE 4. ILIMIT 5. SOURCE SOURCE 6. SOURCE 7. 8. VCC STYLE 30: DRAIN 1 PIN 1. DRAIN 1 2 GATE 2 З. SOURCE 2 4 SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2 5. 6.

7.

8. GATE 1

SOURCE 1/DRAIN 2

STYLE 3: PIN 1. DRAIN, DIE #1 DRAIN, #1 2. DRAIN, #2 З. DRAIN, #2 4. 5. GATE, #2 SOURCE, #2 6. 7 GATE #1 8. SOURCE, #1 STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS THIRD STAGE SOURCE GROUND З. 4. 5. DRAIN 6. GATE 3 SECOND STAGE Vd 7. FIRST STAGE Vd 8. STYLE 11: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. З. GATE 2 4. 5. DRAIN 2 6. DRAIN 2 DRAIN 1 7. 8. DRAIN 1 STYLE 15: PIN 1. ANODE 1 2. ANODE 1 3 ANODE 1 ANODE 1 4. 5. CATHODE, COMMON CATHODE, COMMON CATHODE, COMMON 6. 7. CATHODE, COMMON 8. STYLE 19: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 MIRROR 1 8. STYLE 23: PIN 1. LINE 1 IN COMMON ANODE/GND COMMON ANODE/GND 2. 3 LINE 2 IN 4. LINE 2 OUT 5. COMMON ANODE/GND COMMON ANODE/GND 6. 7. 8. LINE 1 OUT STYLE 27: PIN 1. ILIMIT 2 OVI 0 З. UVLO 4. INPUT+ 5. 6. SOURCE SOURCE SOURCE 7. 8 DRAIN

DATE 16 FEB 2011

STYLE 4: ANODE PIN 1. ANODE 2. ANODE З. 4. ANODE ANODE 5. 6. ANODE 7 ANODE COMMON CATHODE 8. STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 BASE #2 З. COLLECTOR, #2 4. COLLECTOR, #2 5. 6. EMITTER, #2 EMITTER, #1 7. 8. COLLECTOR, #1 STYLE 12: PIN 1. SOURCE SOURCE 2. 3. GATE 4. 5. DRAIN 6 DRAIN DRAIN 7. 8. DRAIN STYLE 16 EMITTER, DIE #1 PIN 1. 2. BASE, DIE #1 EMITTER DIE #2 3 BASE, DIE #2 4. 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 COLLECTOR, DIE #1 7. COLLECTOR, DIE #1 8. STYLE 20: PIN 1. SOURCE (N) GATE (N) SOURCE (P) 2. 3. 4. GATE (P) 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 24: PIN 1. BASE EMITTER 2. 3 COLLECTOR/ANODE COLLECTOR/ANODE 4. 5. CATHODE 6. CATHODE COLLECTOR/ANODE 7. COLLECTOR/ANODE 8. STYLE 28: 11. SW_TO_GND 2. DASIC OFF PIN 1. DASIC_SW_DET З. 4. GND 5. 6. V MON VBULK 7. VBULK 8 VIN

DOCUMENT NUMBER:	98ASB42564B	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOIC-8 NB		PAGE 2 OF 2	

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

7.

8

COLLECTOR, #1

COLLECTOR, #1

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at www.onsemi.com/support/sales